

FDS8812NZ N-Channel PowerTrench[®] MOSFET 30V, 20A, 4.0m Ω

Features

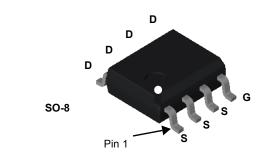
- Max $r_{DS(on)} = 4.0 m\Omega$ at V_{GS} = 10V, I_D = 20A
- Max $r_{DS(on)}$ = 4.9m Ω at V_{GS} = 4.5V, I_D =18A
- HBM ESD protection level of 6.4KV typical (note 3)
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability
- RoHS compliant

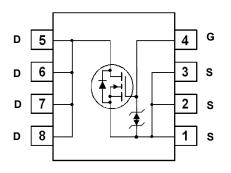


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DS}	Drain to Source Voltage		30	V
V _{GS}	Gate to Source Voltage		±20	V
ID	Drain Current -Continuous	(Note 1a)	20	•
	-Pulsed		80	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 4)	661	mJ
	Power Dissipation	(Note 1a)	2.5	w
PD	Power Dissipation	(Note 1b)	1.0	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

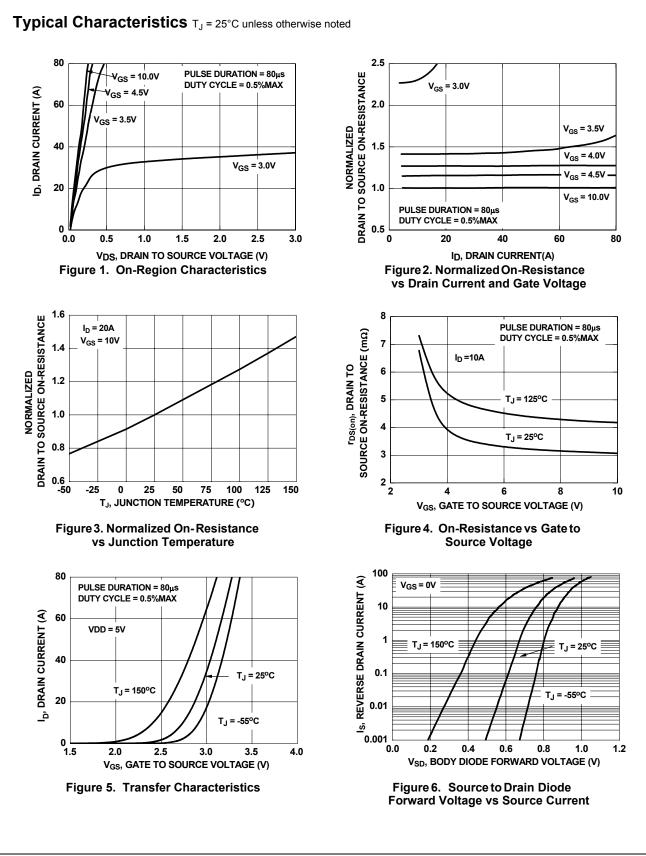
$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	a) 50 °	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	125	

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS8812NZ	FDS8812NZ	13"	12mm	2500 units

ristics ain to Source Breakdown Voltage eakdown Voltage Temperature befficient ro Gate Voltage Drain Current ate to Source Leakage Current ristics (Note 2) ate to Source Threshold Voltage at	$I_{D} = 250\mu A, V_{GS} = 0V$ $I_{D} = 250\mu A, referenced to 25°C$ $V_{DS} = 24V, V_{GS} = 0V$ $V_{GS} = \pm 20V, V_{DS} = 0V$ $V_{GS} = V_{DS}, I_{D} = 250\mu A$ $I_{D} = 250\mu A, referenced to 25°C$ $V_{GS} = 10V, I_{D} = 20A$	30	19 1.8 -7	1 ±10 3	V mV/°C μA μA
eakdown Voltage Temperature efficient ro Gate Voltage Drain Current ate to Source Leakage Current ristics (Note 2) ate to Source Threshold Voltage ate to Source Threshold Voltage mperature Coefficient	$I_{D} = 250\mu\text{A}, \text{ referenced to } 25^{\circ}\text{C}$ $V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$ $V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$ $V_{GS} = V_{DS}, I_{D} = 250\mu\text{A}$ $I_{D} = 250\mu\text{A}, \text{ referenced to } 25^{\circ}\text{C}$		1.8	±10	mV/°C μΑ μΑ
eakdown Voltage Temperature efficient ro Gate Voltage Drain Current ate to Source Leakage Current ristics (Note 2) ate to Source Threshold Voltage ate to Source Threshold Voltage mperature Coefficient	$I_{D} = 250\mu\text{A}, \text{ referenced to } 25^{\circ}\text{C}$ $V_{DS} = 24\text{V}, V_{GS} = 0\text{V}$ $V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$ $V_{GS} = V_{DS}, I_{D} = 250\mu\text{A}$ $I_{D} = 250\mu\text{A}, \text{ referenced to } 25^{\circ}\text{C}$	1	1.8	±10	μΑ μΑ
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ristics (Note 2) ate to Source Threshold Voltage ate to Source Threshold Voltage mperature Coefficient	$V_{GS} = V_{DS}$, $I_D = 250 \mu A$ $I_D = 250 \mu A$, referenced to 25°C	1		ļ	· ·
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ate to Source Threshold Voltage ate to Source Threshold Voltage mperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C	1		3	V
te to Source Threshold Voltage mperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C				-
atic Drain to Source On Resistance	V _{GS} = 10V, I _D = 20A				mV/°C
atic Drain to Source On Resistance			3.1	4.0	
	V _{GS} = 4.5V, I _D = 18A		3.8	4.9	mΩ
	$V_{GS} = 10V, I_D = 20A, T_J = 125^{\circ}C$		4.2	5.3	
rward Transconductance	V _{DS} = 5V, I _D = 20A		87		S
aracteristics					
but Capacitance			5205	6925	pF
Itput Capacitance	50 00		945	1260	pF
everse Transfer Capacitance			580	870	pF
ate Resistance	f = 1MHz		1.5		Ω
naracteristics rn-On Delay Time	V _{DD} = 15V. I _D = 20A		18	33	ns
					ns
					ns
					ns
-					nC
			49	69	nC
tal Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $I_D = 20A$		10		
te to Source Charge			16		nC
ate to Source Charge ate to Drain "Miller" Charge			16 18		
ate to Source Charge ate to Drain "Miller" Charge Diode Characteristics			18	1.2	nC nC
ate to Source Charge ate to Drain "Miller" Charge	$V_{GS} = 0V, I_S = 2.1A$ (Note 2)			1.2	nC
	tput Capacitance verse Transfer Capacitance te Resistance naracteristics	but Capacitance $V_{DS} = 15V, V_{GS} = 0V,$ tput Capacitance $f = 1MHz$ everse Transfer Capacitance $f = 1MHz$ tet Resistance $f = 1MHz$ haracteristics rm-On Delay Time se Time rm-Off Delay Time II Time	but Capacitance $V_{DS} = 15V, V_{GS} = 0V,$ ttput Capacitance $f = 1MHz$ everse Transfer Capacitance $f = 1MHz$ tte Resistance $f = 1MHz$ haracteristics $rn-On Delay Time$ se Time $V_{DD} = 15V, I_D = 20A$ rm-Off Delay Time $V_{GS} = 10V, R_{GEN} = 6\Omega$ II Time I	$\begin{array}{c c} \text{but Capacitance} & V_{\text{DS}} = 15\text{V}, \ \text{V}_{\text{GS}} = 0\text{V}, \\ \text{f} = 1\text{MHz} & 945 \\ \hline & 945$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

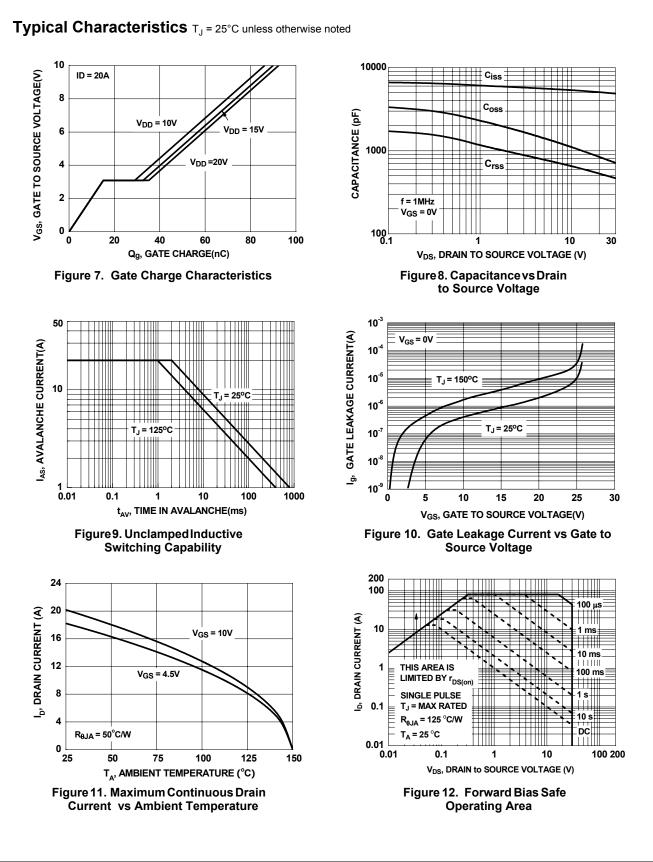
Pulse Test: Pulse Width < 300 us, Duty Cycle < 2%.
 The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.
 Starting T_J = 25°C, L = 3mH, I_{AS} = 21A, V_{DD} = 30V, V_{GS} = 10V.



FDS8812NZ Rev.C1

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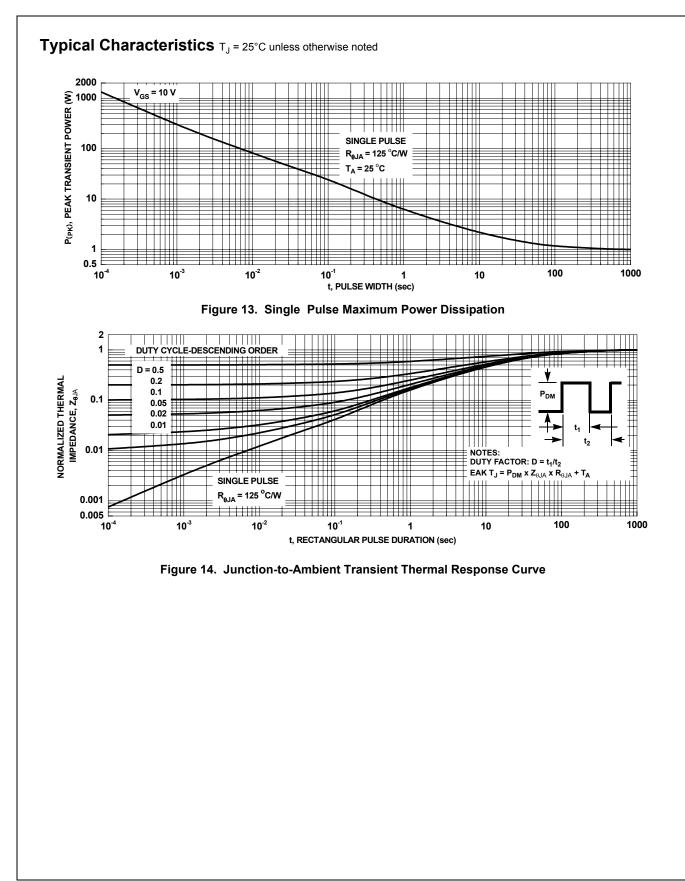


FDS8812NZ Rev.C1

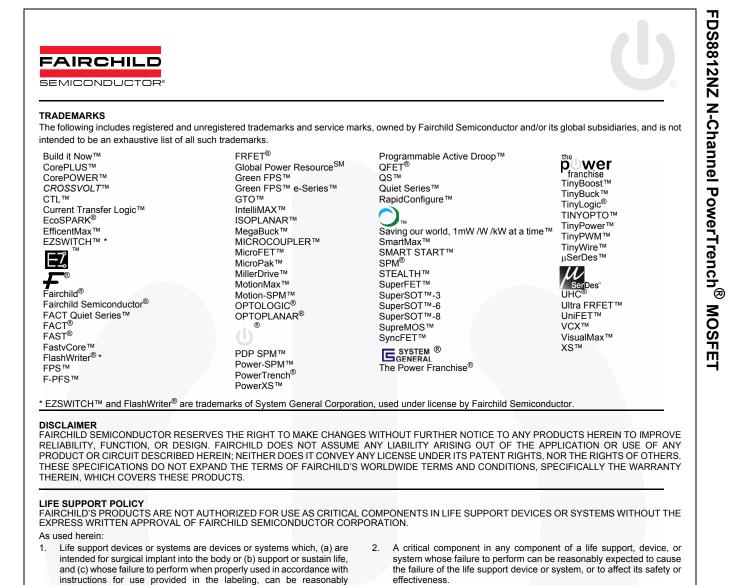
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expected to result in a significant injury of the user.

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Datasheet Identification	Product Status	Definition
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